# MA3J142D (MA142WA), MA3J142E (MA142WK)

### Silicon epitaxial planar type

For switching circuits

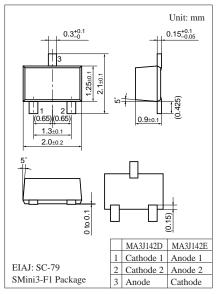
#### ■ Features

 Two isolated elements contained in one package, allowing highdensity mounting

#### ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter		Symbol	Rating	Unit
Reverse voltage		$V_R$	80	V
Maximum peak reverse voltage		$V_{RM}$	80	V
Forward current	Single	$I_F$	100	mA
	Double		150	
Peak forward	Single	$I_{FM}$	225	mA
current	Double		340	
Non-repetitive peak	Single	$I_{FSM}$	500	mA
forward surge current $^{\ast}$	Double		750	
Junction temperature		T <sub>j</sub>	150	°C
Storage temperature		$T_{stg}$	-55 to +150	°C

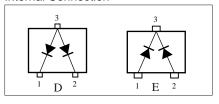
Note) \*: t = 1 s



#### Marking Symbol:

MA3J142D: MO
 MA3J142E: MU

#### Internal Connection

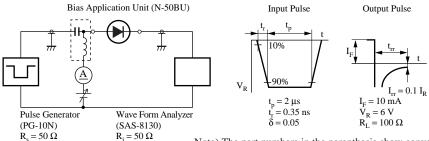


#### ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage		$V_{\mathrm{F}}$	$I_F = 100 \text{ mA}$			1.2	V
Reverse voltage		V <sub>R</sub>	$I_R = 100 \mu A$	80			V
Reverse current		$I_R$	$V_R = 75 \text{ V}$			100	nA
Terminal capacitance	MA3J142D	C <sub>t</sub>	$V_R = 0 V, f = 1 MHz$			15	pF
	MA3J142E					2	
Reverse recovery time *	MA3J142D	t <sub>rr</sub>	$I_F = 10 \text{ mA}, V_R = 6 \text{ V}$			10	ns
	MA3J142E		$I_{rr} = 0.1 \ I_R ,  R_L = 100 \ \Omega$			3	

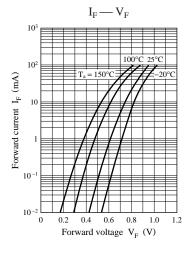
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.

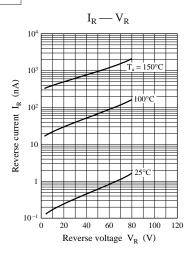
- 2. Absolute frequency of input and output is 100 MHz.
- 3. \*: t<sub>rr</sub> measurement circuit

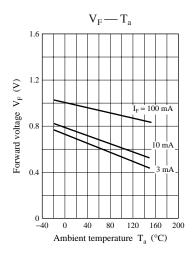


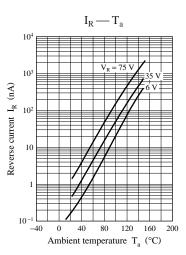
Note) The part numbers in the parenthesis show conventional part number.

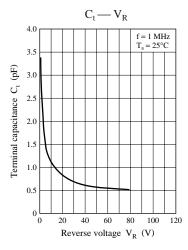
#### Characteristics charts of MA3J142D

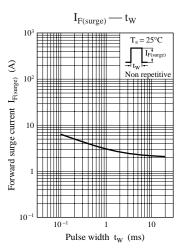








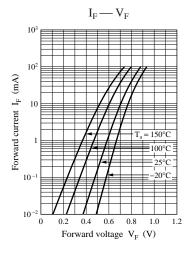


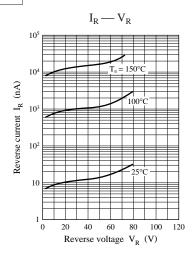


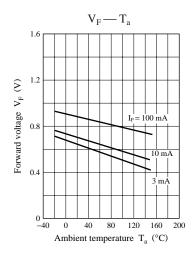
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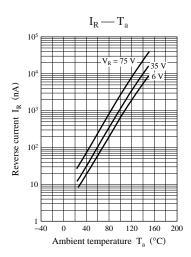
### **Panasonic**

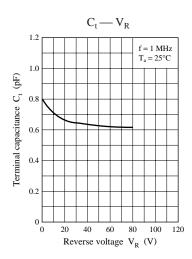
#### Characteristics charts of MA3J142E

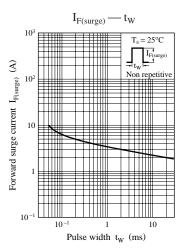












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